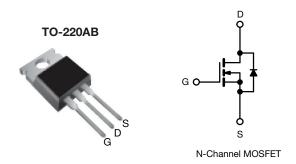
# SiHP068N60EF



**Vishay Siliconix** 

# **EF Series Power MOSFET With Fast Body Diode**



| PRODUCT SUMMARY                       |                 |       |  |  |
|---------------------------------------|-----------------|-------|--|--|
| $V_{DS}$ (V) at $T_J$ max.            | 650             |       |  |  |
| R <sub>DS(on)</sub> typ. (Ω) at 25 °C | $V_{GS} = 10 V$ | 0.059 |  |  |
| Q <sub>g</sub> max. (nC)              | 77              |       |  |  |
| Q <sub>gs</sub> (nC)                  | 19              |       |  |  |
| Q <sub>gd</sub> (nC)                  | 16              |       |  |  |
| Configuration                         | Single          |       |  |  |

## FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
    - Motor drives
  - Battery chargers
  - Solar (PV inverters)

| ORDERING INFORMATION            |                  |
|---------------------------------|------------------|
| Package                         | TO-220AB         |
| Lead (Pb)-free and halogen-free | SiHP068N60EF-GE3 |

| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted) |                         |   |                 |       |      |      |
|--|-------------------------|---|-----------------|-------|------|------|
| PARAMETER  |                         |   | SYMBOL          | LIMIT | UNIT |      |
| Drain-source voltage   |                         | V <sub>DS</sub>   | 600             | V     |      |      |
| Gate-source voltage  |                         |   | V <sub>GS</sub> |       |      | ± 30 |
| Continuous drain current (T <sub>J</sub> = 150 °C)                               | V <sub>GS</sub> at 10 V | $10 \text{ V} \frac{\text{T}_{\text{C}} = 25 \text{ °C}}{\text{T}_{\text{C}} = 100 \text{ °C}}$ |                 | 41    |      |      |
|  | VGS at 10 V             | T <sub>C</sub> = 100 °C   | ID              | 26    | А    |      |
| Pulsed drain current <sup>a</sup>  |                         |   | I <sub>DM</sub> | 115   |      |      |
| Linear derating factor   |                         |   |                 | 2     | W/°C |      |
| Single pulse avalanche energy <sup>b</sup>                                       |                         |   | E <sub>AS</sub> | 226   | mJ   |      |
| Maximum power dissipation  |                         |   | PD              | 250   | W    |      |
| Operating junction and storage temperature range                                 |                         | T <sub>J</sub> , T <sub>stg</sub>   | -55 to +150     | °C    |      |      |
| Drain-source voltage slope   | T <sub>J</sub> = 125 °C |   | -l) / /-lt      | 70    |      |      |
| Reverse diode dV/dt <sup>d</sup>   |                         | dV/dt   | 50              | V/ns  |      |      |
| Soldering recommendations (peak temperature) <sup>c</sup>                        | For                     | 10 s  |                 | 260   | °C   |      |

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 210 A/µs, starting  $T_J$  = 25 °C





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| THERMAL RESISTANCE RATINGS       |                   |       |      |  |
|----------------------------------|-------------------|-------|------|--|
| PARAMETER                        | SYMBOL            | LIMIT | UNIT |  |
| Maximum junction-to-ambient      | R <sub>thJA</sub> | 62    | °C/W |  |
| Maximum junction-to-case (drain) | R <sub>thJC</sub> | 0.5   | C/W  |  |

| <b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u        | inless otherwi         | se noted)  |  |      |       |       |      |
|---|------------------------|--|--|------|-------|-------|------|
| PARAMETER   | SYMBOL                 | TES  | MIN.   | TYP. | MAX.  | UNIT  |      |
| Static  |                        |  |  | •    | •     | •     |      |
| Drain-source breakdown voltage                            | V <sub>DS</sub>        | $V_{GS} = 0 V, I_D = 250 \mu A$  |  | 600  | -     | -     | V    |
| V <sub>DS</sub> temperature coefficient                   | $\Delta V_{DS}/T_{J}$  | Referenc   | Reference to 25 °C, $I_D = 1 \text{ mA}$               |      | 0.63  | -     | V/°C |
| Gate-source threshold voltage (N)                         | V <sub>GS(th)</sub>    | V <sub>DS</sub> =  | = V <sub>GS</sub> , I <sub>D</sub> = 250 μA            | 3    | -     | 5     | V    |
|   | I <sub>GSS</sub>       | $V_{GS} = \pm 20 \text{ V}$  |  | -    | -     | ± 100 | nA   |
| Gate-source leakage                                       |                        | N N  | $V_{GS} = \pm 30 \text{ V}$                            |      | -     | ± 1   | μA   |
| Zara gata valtaga drain aurrant                           | 1                      | V <sub>DS</sub> =  | $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ |      | -     | 1     | μA   |
| Zero gate voltage drain current                           | I <sub>DSS</sub>       | $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ |  | -    | -     | 2     | mA   |
| Drain-source on-state resistance                          | R <sub>DS(on)</sub>    | $V_{GS} = 10 V$  | I <sub>D</sub> = 16 A                                  | -    | 0.059 | 0.068 | Ω    |
| Forward transconductance                                  | <b>g</b> <sub>fs</sub> | $V_{DS} = 30 \text{ V}, \text{ I}_{D} = 16 \text{ A}$  |  | -    | 9     | -     | S    |
| Dynamic   |                        |  |  |      |       |       |      |
| Input capacitance   | C <sub>iss</sub>       |  | $V_{GS} = 0 V$ ,                                       |      | 2628  | -     |      |
| Output capacitance  | C <sub>oss</sub>       | `  | $V_{\rm DS} = 100  \rm V,$                             | -    | 122   | -     |      |
| Reverse transfer capacitance                              | C <sub>rss</sub>       |  | f = 1 MHz  | -    | 7     | -     | _    |
| Effective output capacitance, energy related <sup>a</sup> | C <sub>o(er)</sub>     |  | $V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V                |      | 87    | -     | pF   |
| Effective output capacitance, time related <sup>b</sup>   | C <sub>o(tr)</sub>     | $v_{\rm DS} = 0$   |  |      | 543   | -     |      |
| Total gate charge   | Qg                     |  |  | -    | 51    | 77    |      |
| Gate-source charge  | Q <sub>gs</sub>        | $V_{GS} = 10 V$  | I <sub>D</sub> = 16 A, V <sub>DS</sub> = 480 V         | -    | 19    | -     | nC   |
| Gate-drain charge   | Q <sub>gd</sub>        |  |  | -    | 16    | -     | 1    |
| Turn-on delay time  | t <sub>d(on)</sub>     | V <sub>DD</sub> = 480 V, I <sub>D</sub> = 16 A,  |  | -    | 27    | 54    | ns   |
| Rise time   | t <sub>r</sub>         |  |  | -    | 55    | 83    |      |
| Turn-off delay time                                       | t <sub>d(off)</sub>    | V <sub>GS</sub> =  | $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$    |      | 53    | 80    |      |
| Fall time   | t <sub>f</sub>         |  |  |      | 35    | 70    |      |
| Gate input resistance                                     | R <sub>g</sub>         | f = 1 MHz, open drain  |  | 0.3  | 0.7   | 1.4   | Ω    |
| Drain-Source Body Diode Characteristic                    | cs                     |  |  |      |       |       |      |
| Continuous source-drain diode current                     | ۱ <sub>S</sub>         | MOSFET sym<br>showing the  | MOSFET symbol  |      | -     | 41    |      |
| Pulsed diode forward current                              | I <sub>SM</sub>        | integral reverse<br>p - n junction diode   |  | -    | -     | 115   | A    |
| Diode forward voltage                                     | V <sub>SD</sub>        | T <sub>J</sub> = 25 °C, I <sub>S</sub> = 16 A, V <sub>GS</sub> = 0 V                         |  | -    | -     | 1.2   | V    |
| Reverse recovery time                                     | t <sub>rr</sub>        |  |  | -    | 152   | 304   | ns   |
| Reverse recovery charge                                   | Q <sub>rr</sub>        |  | $T_J = 25 \ ^{\circ}C, I_F = I_S = 16 \ A,$            |      | 1     | 2     | μC   |
| Reverse recovery current                                  | I <sub>BBM</sub>       | di/dt = 100 A/µs, V <sub>R</sub> = 400 V   |  | -    | 14    | -     | A    |

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

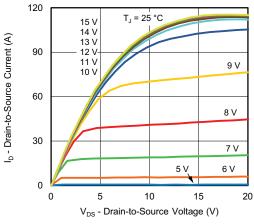


Fig. 1 - Typical Output Characteristics

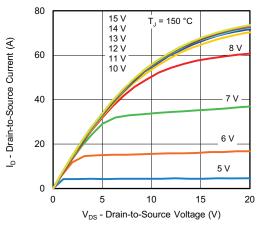


Fig. 2 - Typical Output Characteristics

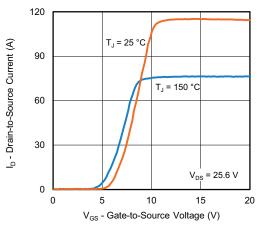


Fig. 3 - Typical Transfer Characteristics

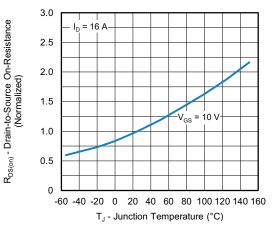


Fig. 4 - Normalized On-Resistance vs. Temperature

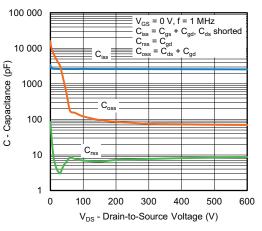
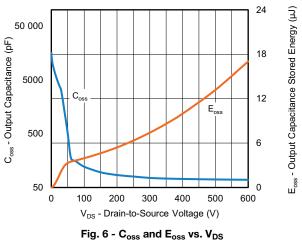


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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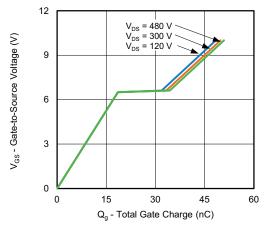


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

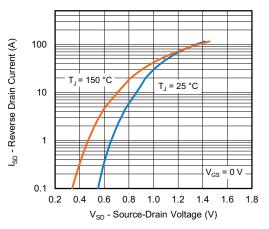


Fig. 8 - Typical Source-Drain Diode Forward Voltage

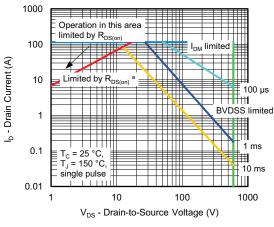


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

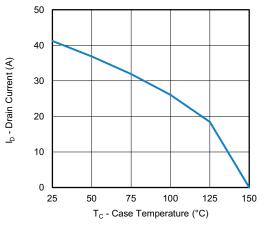


Fig. 10 - Maximum Drain Current vs. Case Temperature

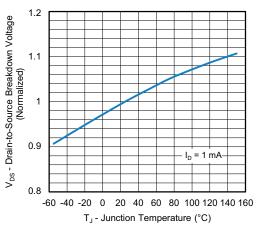
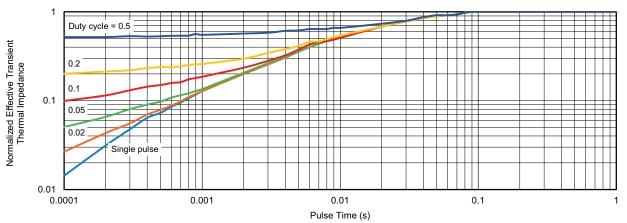


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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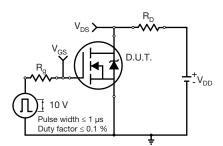


Fig. 13 - Switching Time Test Circuit

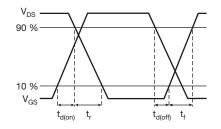


Fig. 14 - Switching Time Waveforms

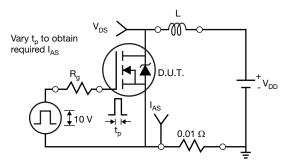


Fig. 15 - Unclamped Inductive Test Circuit

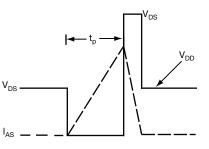


Fig. 16 - Unclamped Inductive Waveforms

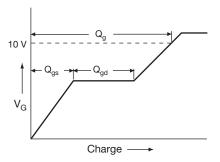


Fig. 17 - Basic Gate Charge Waveform

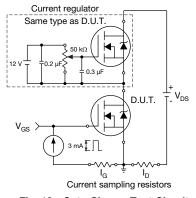


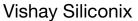
Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit

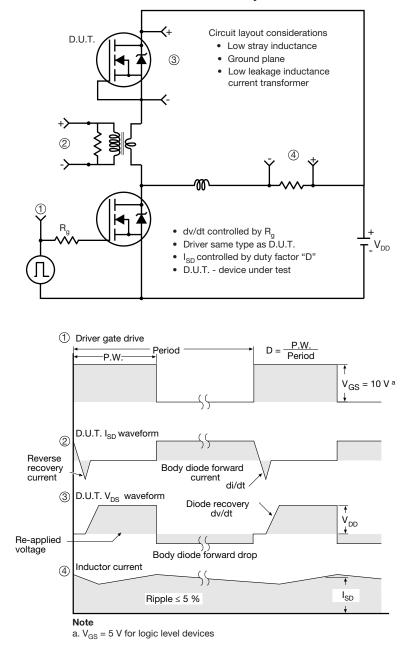


Fig. 19 - For N-Channel

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